

Dual N-Ch MOSFET

General Description

The WSP6946 is the highest performance trench N-ch MOSFET with extreme high cell density , which provide excellent $\mathsf{R}_{\mathsf{DSON}}$ and gate charge for most of the synchronous buck converter applications .

The WSP6946 meet the RoHS and Green Product requirement , 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

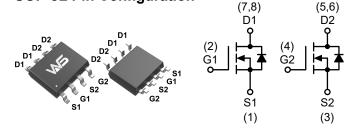
Product Summery

BV _{DSS}	R _{DSON}	I _D
60V	43mΩ	6.5A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

SOP-8L Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	60	V
V _{GS}	Gate-Source Voltage	±20	V
I₀@T _C =25℃	Continuous Drain Current, V _{GS} @ 10V ¹	6.5	А
I _D @T _C =70℃	Continuous Drain Current, V _{GS} @ 10V ¹	4.5	A
I _{DM}	Pulsed Drain Current ²	24	A
EAS	Single Pulse Avalanche Energy ³	12	mJ
I _{AS}	Avalanche Current	16	A
P₀@T _A =25℃	Total Power Dissipation ⁴	2.5	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range -55 to 150		°C

Thermal Data

Symbol	Parameter		Max.	Unit
R _{eja}	Thermal Resistance Junction-ambient ¹		90	°C/W
R _{eJC}	Thermal Resistance Junction-Case ¹		50	°C/W



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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	60			V	
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, I_D=1mA		0.044		V/℃	
Б	Static Drain-Source On-Resistance ²	V _{GS} =10V , I _D =6.3A	0V , I _D =6.3A 43		52		
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =4.5V , I _D =4A		46	60	mΩ	
V _{GS(th)}	Gate Threshold Voltage		1.0	2.0	3.0	V	
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	— V _{GS} =V _{DS} , I _D =250uA		-4.8		mV/℃	
		V _{DS} =48V , V _{GS} =0V , T _J =25°C			1		
I _{DSS}	Drain-Source Leakage Current	V_{DS} =48V , V_{GS} =0V , T_{J} =55 $^{\circ}\mathrm{C}$			5	uA	
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =4A		28.3		S	
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5	5	Ω	
Qg	Total Gate Charge (10V)			14	20		
Q _{gs}	Gate-Source Charge	V _{DS} =48V , V _{GS} =10V , I _D =6.3A		2.6		nC	
Q _{gd}	Gate-Drain Charge			2.2			
T _{d(on)}	Turn-On Delay Time			6	11		
Tr	Rise Time	V_{DD} =30V , V_{GEN} =10V , R_{G} =6 Ω		8	15		
T _{d(off)}	Turn-Off Delay Time	I _D =4A ,RL=30Ω		6	11	ns	
T _f	Fall Time			23	42		
C _{iss}	Input Capacitance			870			
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		70		pF	
C _{rss}	Reverse Transfer Capacitance			35			

Guaranteed Avalanche Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy 5	V_{DD} =25V , L=0.1mH , I _{AS} =12A	10			mJ

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,6}				2.5	А
I _{SM}	Pulsed Source Current ^{2,6}	$V_G = V_D = 0V$, Force Current			24	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃			1.1	V
trr	Reverse Recovery Time			20		nS
Q _{rr}	Reverse Recovery Charge	l⊧=6.3A , dl/dt=100A/μs , Tյ=25℃		18		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width $\,\leq\,$ 300us , duty cycle $\,\leq\,$ 2%

3. The EAS data shows Max. rating . The test condition is $V_{\text{DD}}\text{=}25\text{V}, V_{\text{GS}}\text{=}10\text{V}, \text{L=}0.1\text{mH}, \text{I}_{\text{AS}}\text{=}12\text{A}$

4.The power dissipation is limited by 150 $^\circ\!\mathrm{C}$ junction temperature

5.The Min. value is 100% EAS tested guarantee.

6. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



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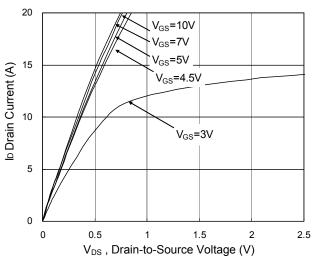
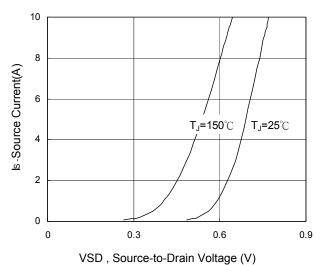
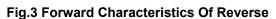
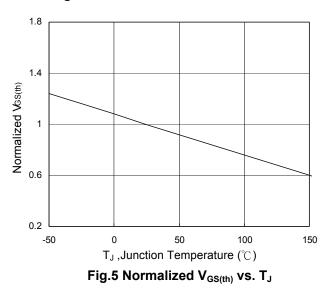


Fig.1 Typical Output Characteristics







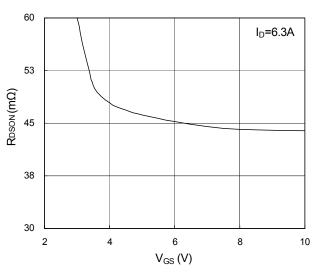


Fig.2 On-Resistance vs. Gate-Source

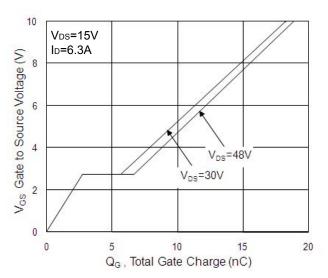
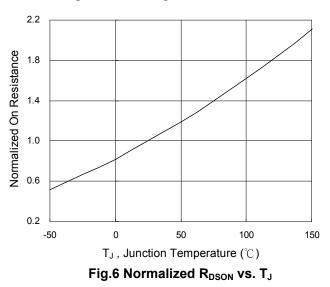
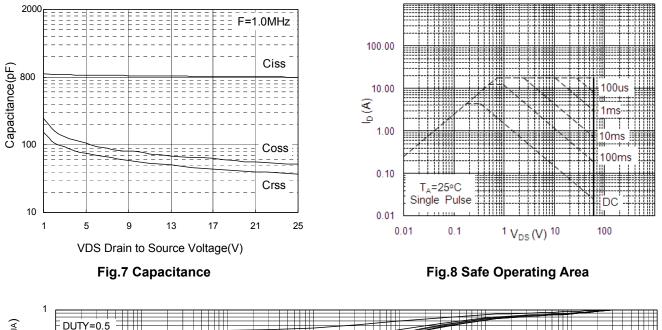


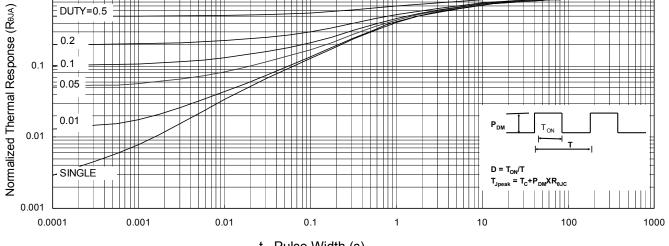
Fig.4 Gate-Charge Characteristics





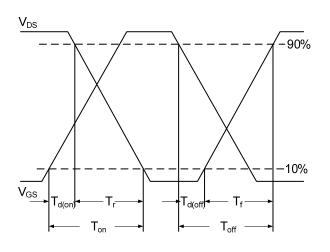
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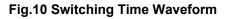




t , Pulse Width (s)







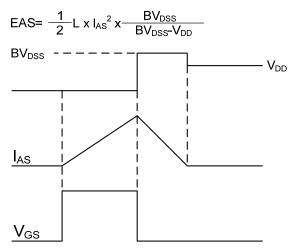
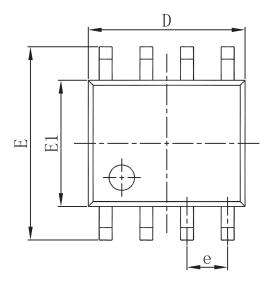
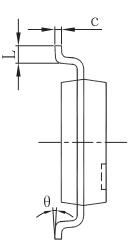


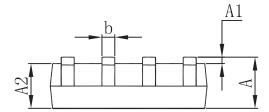
Fig.11 Unclamped Inductive Switching Waveform



Packaging information







Symbol	Dimensions In Millimeters		Dimensions	In Inches
	Min	Max	Min	Max
А	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
с	0.170	0.250	0.007	0.010
D	4.800	5.000	0.189	0. 197
e	1.270 (BSC)		0.050 (BSC)	
Е	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0 °	8°	0°	8°



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